506196634 08/10/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6243373

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WESLEY JAMES HOLLAND	03/25/2020
MEHRAD TAVAKOLI	04/16/2020
INJOON HONG	04/17/2020
HUANG HUANG	04/23/2020
SIMON PETER WILLIAM BOOTH	07/15/2020
GERHARD REITMAYR	04/16/2020

RECEIVING PARTY DATA

Name: QUALCOMM INCORPORATED	
Street Address: 5775 MOREHOUSE DRIVE	
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16667754	

CORRESPONDENCE DATA

Fax Number: (650)461-7701

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6504617700

Email: patentdocketing@polsinelli.com, mknight@polsinelli.com,

SRamirez@Polsinelli.com

Correspondent Name: POLSINELLI LLP

Address Line 1: 1661 PAGE MILL ROAD

Address Line 4: PALO ALTO, CALIFORNIA 94304

ATTORNEY DOCKET NUMBER: 192643 (627314)

NAME OF SUBMITTER: MICHAEL KNIGHT

SIGNATURE: /Michael Knight/

DATE SIGNED: 08/10/2020

PATENT 506196634 REEL: 053450 FRAME: 0132

Total Attachments: 18 source=192643 ASG 2020 08 07 signed#page1.tif source=192643 ASG 2020 08 07 signed#page2.tif source=192643_ASG_2020_08_07_signed#page3.tif source=192643_ASG_2020_08_07_signed#page4.tif source=192643_ASG_2020_08_07_signed#page5.tif source=192643_ASG_2020_08_07_signed#page6.tif source=192643_ASG_2020_08_07_signed#page7.tif source=192643_ASG_2020_08_07_signed#page8.tif source=192643 ASG 2020 08 07 signed#page9.tif source=192643_ASG_2020_08_07_signed#page10.tif source=192643_ASG_2020_08_07_signed#page11.tif source=192643 ASG 2020 08 07 signed#page12.tif source=192643 ASG 2020 08 07 signed#page13.tif source=192643_ASG_2020_08_07_signed#page14.tif source=192643_ASG_2020_08_07_signed#page15.tif source=192643 ASG 2020 08 07 signed#page16.tif source=192643_ASG_2020_08_07_signed#page17.tif source=192643 ASG 2020 08 07 signed#page18.tif

WHEREAS, WE,

- 1. Wesley James HOLLAND, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714.
- Mehrad TAVAKOLI, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714.
- Injoon HONG, having a mailing address located at 5775 Morehouse Drive, San Diego. California 92121-1714.
- Huang HUANG, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714.
- Simon Peter William BOOTH, having a mailing address located at 5775 Morehouse Drive.
 San Diego, California 92121-1714.
- Gerhard REITMAYR, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to POSE ESTIMATION IN EXTENDED REALITY SYSTEMS (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor, and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/667,754 filed October 29, 2019. Qualcomm Reference Number 192643, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument:

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries:

Qualcomm Reference Number: 192643

Page 3 of 3

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	San Diego. (A	, on	3/25/20	Aula Janes Tolland Wesley James HOLLAND
	City, State		Date	Wesley James HOLLAND
Done at		, on	Date	
	City, State		Date	Mehrad TAVAKOLI
Done at	City, State	, on	Date	Injoon HONG
Done at		, on		
	City, State		Date	Huang HUANG
Done at		_, on _	Date	
	City, State		Date	Simon Peter William BOOTH
Done at	City, State	_, on _		
	City, State		Date	Gerhard REITMAYR

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- 5. Simon Peter William BOOTH, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714.
- Gerhard REITMAYR, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,

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PATENT

Qualcomm Reference Number: 192643

Page 3 of 3

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Done at		, on		
	City, State		Date	Wesley James HOLLAND
Done at	City, State	/) _,on_0	41142020	M/7cm/
	City, State		Date	Mehrad TAVAKOLI
Done at		, on		
	City, State		Date	Injoan HONG
Done at	City, State	, ON	Date	Huang HUANG
Done at				
	City, State		Date	Simon Peter William BOOTH
Done at				
- Divo se	City, State	3 743	Date	Gerhard REITMAYR

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- 6. Gerhard REITMAYR, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,

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Qualcomm Reference Number: 192643 Page 3 of 3

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Done at		, on		
	City, State		Date	Wesley James HOLLAND
Done at _		_, on _		
	City, State		Date	Mehrad TAVAKOLI
Done at_	San Diego: (A	_, on _	Apr 1/7, 2020 Date	Injoon HONG
	**			
Done at		, on		
an _i a	City, State		Date	Huang HUANG
			·	
Done at		, on		
	City, State		Date	Simon Peter William BOOTH
Done at _		_, on		
	City, State			Gerhard REITMAYR

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Done at	, on	
City, State	Date	Wesley James HOLLAND
Done at	, on	
City, State	Date	Mehrad TAVAKOLI
Done at	, on	
City, State	Date	Injoon HONG
Done at Som Dieso, cA	, on <u>4/23/2020</u> Date	Moto
City, State	Date	Huang HUANG
Done at	, on	
City, State	Date	Simon Peter William BOOTH
Done at	QD.	
City, State	on	Gerhard REITMAYR

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Done at	, on City, State	Date	Wesley James HOLLAND
Done at	City, State	Date	Mehrad TAVAKOLI
Done at _	, on City State	Date	Injoon HONG
Done at	on City, State	Date	Huang HUANG
Done at	Som Diege (4) on City, State	7/15/2000 Date	Simon Peter William BOOTH
Done at _	on City State	Date	Gerhard REITMAYR

WHEREAS, WE,

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WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/667,754 filed October 29, 2019, Qualcomm Reference Number 192643, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

PATENT

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		,on	
	City, State	Date	Wesley James HOLLAND
Done at _		, on	
	City, State	Date	Mehrad TAVAKOLI
Done at		• on	
-	City, State	Date	Injoon HONG
Daniel		-	
Done at _	City, State	Date Date	Huang HUANG
Done at_	City, State	on	Simon Peter William BOOTH
		, ,	/. ////
Done at /	elMor, CA	_, on <u>4/16/2020</u>	
	City, State	Date	//Gerhard RETTMAYR

PATENT REEL: 053450 FRAME: 0151

RECORDED: 08/10/2020